

REVISIONS																			
LTR	DESCRIPTION	DATE (YR-MO-DA)	APPROVED																
A	Add device type 03. Remove vendor CAGE 64155 for device type 02. Remove vendor CAGE 06665. Make changes to table I, 1.2.2, figure 1, and editorial changes throughout.	93-03-17	M. A. FRYE																
B	Changes in accordance with NOR 5962-R219-94	94-07-08	M. A. FRYE																
C	Add vendor CAGE 24355 to device type 02, and class V for case outlines 2, and H. Update to current boiler plate and editorial changes throughout.	97-05-30	R. MONNIN																

REV																			
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REV STATUS OF SHEETS	REV	C	C	C	C	C	C	C	C	C	C	C	C	C	C	C
	SHEET	1	2	3	4	5	6	7	8	9	10	11	12	13		

PMIC N/A	PREPARED BY Charles E. Besore	DEFENSE SUPPLY CENTER COLUMBUS COLUMBUS, OHIO 43216
STANDARD MICROCIRCUIT DRAWING THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE AMSC N/A	CHECKED BY Raymond Monnin	
	APPROVED BY D. A. DiCenzo	MICROCIRCUIT, LINEAR, PRECISION, LOW OFFSET, OPERATIONAL AMPLIFIER, MONOLITHIC SILICON
	DRAWING APPROVAL DATE 88-07-26	
	REVISION LEVEL C	

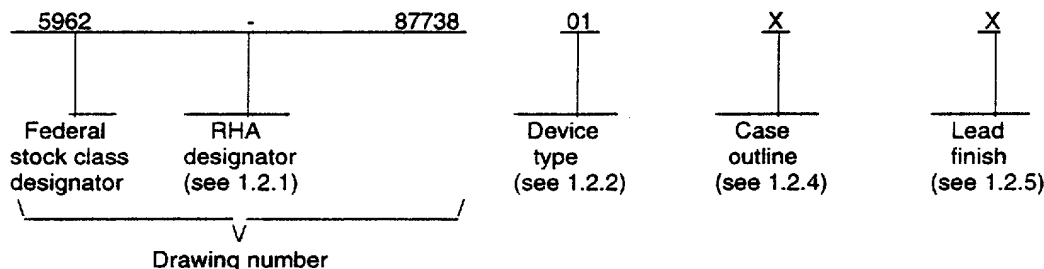
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1. SCOPE

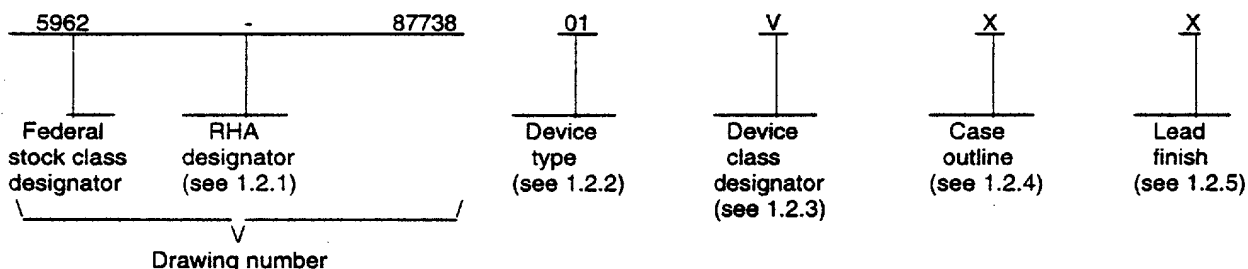
1.1 Scope. This drawing documents two product assurance class levels consisting of high reliability (device classes Q and M) and space application (device class V). A choice of case outlines and lead finishes are available and are reflected in the Part or Identifying Number (PIN). When available, a choice of Radiation Hardness Assurance (RHA) levels are reflected in the PIN.

1.2 PIN. The PIN is as shown in the following examples.

For device classes M and Q:



For device class V:



1.2.1 RHA designator. Device classes Q and V RHA marked devices meet the MIL-PRF-38535 specified RHA levels and are marked with the appropriate RHA designator. Device class M RHA marked devices meet the MIL-PRF-38535, appendix A specified RHA levels and are marked with the appropriate RHA designator. A dash (-) indicates a non-RHA device.

1.2.2 Device types. The device types identify the circuit function as follows:

Device type	Generic number	Circuit function
01	LT1001, OP-77B	Precision operational amplifier
02	OP-77A	Precision operational amplifier
03	LT1001A	Precision operational amplifier

1.2.3 Device class designator. The device class designator is a single letter identifying the product assurance level as listed below. Since the device class designator has been added after the original issuance of this drawing, device classes M and Q designators will not be included in the PIN and will not be marked on the device.

Device class	Device requirements documentation
M	Vendor self-certification to the requirements for MIL-STD-883 compliant, non-JAN class level B microcircuits in accordance with MIL-PRF-38535, appendix A
Q or V	Certification and qualification to MIL-PRF-38535

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1.2.4 Case outlines. The case outlines are as designated in MIL-STD-1835 and as follows:

<u>Outline letter</u>	<u>Descriptive designator</u>	<u>Terminals</u>	<u>Package style</u>
G	MACY1-X8	8	Can
P	GDIP1-T8 or CDIP2-T8	8	Dual-in-line
2	CQCC1-N20	20	Square leadless chip carrier
H	GDFP1-F10 or CDFP2-F10	10	Flat pack

1.2.5 Lead finish. The lead finish is as specified in MIL-PRF-38535 for device classes Q and V or MIL-PRF-38535, appendix A for device class M.

1.3 Absolute maximum ratings. 1/

Supply voltage.....	±22.0 V dc
Internal power dissipation	500 mW
input voltage 2/.....	±22.0 V dc
Differential input voltage.....	±30 Vdc
Output short-circuit duration.....	Indefinite
Lead temperature (soldering, 10 seconds	+300°C
Storage temperature range	-65°C to +150°C
Thermal resistance, junction-to-case (θ_{JC}).....	See MIL-STD-1835
Thermal resistance, junction-to-ambient (θ_{JA}):	
Case G.....	+150°C/W
Case P.....	+119°C/W
Case 2.....	+110°C/W
Case H.....	+150°C/W
Junction temperature (T_J).....	+150°C

1.4 Recommended operating conditions.

Supply voltage range	±3 V dc to ±18 V dc
Ambient operating temperature range (T_A)	-55°C to +125°C

2. APPLICABLE DOCUMENTS

2.1 Government specification, standards, and handbooks. The following specification, standards, and handbooks form a part of this drawing to the extent specified herein. Unless otherwise specified, the issues of these documents are those listed in the issue of the Department of Defense Index of Specifications and Standards (DoDISS) and supplement thereto, cited in the solicitation..

SPECIFICATION

MILITARY

MIL-PRF-38535 - Integrated Circuits, Manufacturing, General Specification for.

STANDARDS

MILITARY

MIL-STD-883 - Test Methods and Procedures for Microelectronics.
MIL-STD-973 - Configuration Management.
MIL-STD-1835 - Microcircuit Case Outlines.

1/ Stresses above the absolute maximum rating may cause permanent damage to the device. Extended operation at the maximum levels may degrade performance and affect reliability.

2/ For supply voltage less than ±22 V, the absolute maximum input voltage is equal to the supply voltage.

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HANDBOOKS

MILITARY

- MIL-HDBK-103 - List of Standard Microcircuit Drawings (SMD's).
- MIL-HDBK-780 - Standard Microcircuit Drawings.

(Unless otherwise indicated, copies of the specification, standards, and handbooks are available from the Standardization Document Order Desk, 700 Robbins Avenue, Building 4D, Philadelphia, PA 19111-5094.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing takes precedence. Nothing in this document, however, supersedes applicable laws and regulations unless a specific exemption has been obtained.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements for device classes Q and V shall be in accordance with MIL-PRF-38535 and as specified herein or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein. The individual item requirements for device class M shall be in accordance with MIL-PRF-38535, appendix A for non-JAN class level B devices and as specified herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-PRF-38535 and herein for device classes Q and V or MIL-PRF-38535, appendix A and herein for device class M.

3.2.1 Case outlines. The case outlines shall be in accordance with 1.2.4 herein.

3.2.2 Terminal connections. The terminal connections shall be as specified on figure 1.

3.3 Electrical performance characteristics and postirradiation parameter limits. Unless otherwise specified herein, the electrical performance characteristics and postirradiation parameter limits are as specified in table I and shall apply over the full ambient operating temperature range.

3.4 Electrical test requirements. The electrical test requirements shall be the subgroups specified in table IIA. The electrical tests for each subgroup are defined in table I.

3.5 Marking. The part shall be marked with the PIN listed in 1.2 herein. In addition, the manufacturer's PIN may also be marked as listed in MIL-HDBK-103. For packages where marking of the entire SMD PIN number is not feasible due to space limitations, the manufacturer has the option of not marking the "5962-" on the device. For RHA product using this option, the RHA designator shall still be marked. Marking for device classes Q and V shall be in accordance with MIL-PRF-38535. Marking for device class M shall be in accordance with MIL-PRF-38535, appendix A.

3.5.1 Certification/compliance mark. The certification mark for device classes Q and V shall be a "QML" or "Q" as required in MIL-PRF-38535. The compliance mark for device class M shall be a "C" as required in MIL-PRF-38535, appendix A.

3.6 Certificate of compliance. For device classes Q and V, a certificate of compliance shall be required from a QML-38535 listed manufacturer in order to supply to the requirements of this drawing (see 6.6.1 herein). For device class M, a certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in MIL-HDBK-103 (see 6.6.2 herein). The certificate of compliance submitted to DSCC-VA prior to listing as an approved source of supply for this drawing shall affirm that the manufacturer's product meets, for device classes Q and V, the requirements of MIL-PRF-38535 and herein or for device class M, the requirements of MIL-PRF-38535, appendix A and herein.

3.7 Certificate of conformance. A certificate of conformance as required for device classes Q and V in MIL-PRF-38535 or for device class M in MIL-PRF-38535, appendix A shall be provided with each lot of microcircuits delivered to this drawing.

3.8 Notification of change for device class M. For device class M, notification to DSCC-VA of change of product (see 6.2 herein) involving devices acquired to this drawing is required for any change as defined in MIL-STD-973.

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TABLE 1. Electrical performance characteristics.

Test	Symbol	Conditions -55°C ≤ T _A ≤ +125°C V _S = ±15 V unless otherwise specified	Group A subgroups	Device type	Limits 1/		Unit
					Min	Max	
Long term input offset voltage stability	$\Delta V_{OS} /$ Δtime	2/ 3/	1	01, 02		1.5	$\mu\text{V} / \text{Mo}$
				03		1.0	
Average input offset voltage drift 3/	$\Delta V_{OS} /$ Δtemp		2, 3	01	-1.0	10	$\mu\text{V} / ^\circ\text{C}$
				02, 03	-0.6	0.6	
Input offset current	I_{OS}		1	01	-3.8	3.8	nA
			2, 3		-7.6	7.6	
			1	02	-1.5	1.5	
			2, 3		-2.2	2.2	
			1	03	-2.0	2.0	
			2, 3		-4.0	4.0	
Input bias current	I_B		1	01	-4.0	4.0	nA
			2, 3		-8.0	8.0	
			1	02, 03	-2.0	2.0	
			2, 3		-4.0	4.0	
Input voltage range	+V _{IN}		1, 2, 3	ALL	+13.0		V
	-V _{IN}					-13.0	

See footnotes at end of table.

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TABLE I. Electrical performance characteristics - continued.

Test	Symbol	Conditions -55°C ≤ T _A ≤ +125°C V _S = ±15 V unless otherwise specified		Group A subgroups	Device type	Limits 1/		Unit
						Min	Max	
Power dissipation	P _D	No load		1	01		80	mW
				2, 3			100	
			V _S = ±3 V	1			8	
				1	02		60	
				2, 3			75	
			V _S = ±3 V	1			4.5	
				1	03		75	
				2, 3			90	
			V _S = ±3 V	1			6.0	
Input resistance 3/ differential mode	R _{IN}	T _A = +25°C		1	ALL	15		MΩ
Common mode rejection ratio	CMRR	V _{CM} = ±13 V		1	01	110		dB
				2, 3		106		
				1, 2, 3	02	120		
				1	03	114		
				2, 3		110		
Power supply rejection ratio	PSRR	V _S = ±3 V to ±18 V		1	01, 02	106		dB
				2, 3		100		
				1	03	110		
				2, 3		104		

See footnotes at end of table.

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TABLE I. Electrical performance characteristics - continued.

Test	Symbol	Conditions -55°C ≤ T _A ≤ +125°C V _S = ±15 V unless otherwise specified	Group A subgroups	Device type	Limits <u>1/</u>		Unit
					Min	Max	
Input offset voltage <u>4/</u>	V _{OS}		4	01	-60	60	μV
			2, 3		-160	160	
			4	02	-25	25	
			2, 3		-60	60	
			4	03	-15	15	
			2, 3		-60	60	
Large signal voltage gain	A _{VOL}	R _L ≥ 2 kΩ, V _O = ±12 V	4	01	400		V / mV
		R _L ≥ 1 kΩ, V _O = ±10 V			250		
		R _L ≥ 2 kΩ, V _O = ±10 V	5, 6		200		
		R _L ≥ 2 kΩ, V _O = ±10 V	4	02	5000		
			5, 6		2000		
		R _L ≥ 2 kΩ, V _O = ±12 V	4	03	450		
		R _L ≥ 1 kΩ, V _O = ±10 V			300		
		R _L ≥ 2 kΩ, V _O = ±10 V	5, 6		300		
Output voltage swing	+V _{OUT}	R _L ≥ 1 kΩ,	4	ALL	+ 12.0		V
		R _L ≥ 2 kΩ,	4		+ 12.5		
			5, 6		+ 12.0		
	-V _{OUT}	R _L ≥ 1 kΩ,	4			- 12.0	
			4			-12.5	
		R _L ≥ 2 kΩ,	5, 6			- 12.0	

See footnotes at end of table.

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TABLE I. Electrical performance characteristics - continued.

Test	Symbol	Conditions -55°C ≤ T _A ≤ +125°C V _S = ±15 V unless otherwise specified		Group A subgroups	Device type	Limits <u>1/</u>		Unit
						Min	Max	
Slew rate <u>3/</u>	SR	R _L ≥ 2 kΩ, T _A = +25°C		7	ALL	0.1		V/μs
Input noise voltage <u>3/ 5/</u>	en _{PP}	0.1 Hz to 10 Hz, T _A = +25°C		7	ALL		0.6	μV _{P-P}
Input noise voltage density <u>5/</u>	en	fo = 10 Hz	T _A = +25°C	7	ALL		18.0	nV/√Hz
		fo = 1000 Hz					11.0	
Input noise current <u>3/ 5/</u>	in	fo = 10 Hz	T _A = +25°C	7	ALL		.80	pA/√Hz
		fo = 1000 Hz					.17	
Gain-bandwidth product <u>3/</u>	GBW	T _A = +25°C		7	ALL	0.4		MHz

1/ The algebraic convention, whereby the most negative value is a minimum and the most positive is a maximum, is used in this table. Negative current shall be defined as conventional current flow out of device terminal.

2/ Long term input offset voltage stability refers to the average trend line of offset voltage verse time over extended periods after the first 30 days of operation. Excluding the first hour of operation, changes in V_{OS} during the first 30 days are typically 2.5 μV.

3/ If not tested, shall be guaranteed to the limits specified in table I herein.

4/ For device types 01 and 02, inputs offset voltage is measured with high speed test equipment approximately 1 second after power is applied. For device type 03, input offset voltage is measured after power is applied and the device is fully warmed up.

5/ 10 Hz noise voltage density is sample tested on every lot.

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Device types	01, 02, 03	01, 02	02
Case outlines	G and P	2	H
Terminal number	Terminal symbol		
1	V _{OS} TRIM	NC	NC
2	INPUT-	V _{OS} TRIM	V _{OS} TRIM
3	INPUT+	NC	-IN
4	-V _S	NC	+IN
5	NC	INPUT-	V-
6	OUTPUT	NC	NC
7	+V _S	INPUT+	OUT
8	V _{OS} TRIM	NC	V+
9	---	NC	V _{OS} TRIM
10	---	-V _S	NC
11	---	NC	---
12	---	NC	---
13	---	NC	---
14	---	NC	---
15	---	OUTPUT	---
16	---	NC	---
17	---	+V _S	---
18	---	NC	---
19	---	NC	---
20	---	V _{OS} TRIM	---

NC = No connection

FIGURE 1. Terminal connections.

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3.9 Verification and review for device class M. For device class M, DSCC, DSCC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

3.10 Microcircuit group assignment for device class M. Device class M devices covered by this drawing shall be in microcircuit group number 49 (see MIL-PRF-38535, appendix A).

4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. For device classes Q and V, sampling and inspection procedures shall be in accordance with MIL-PRF-38535 or as modified in the device manufacturer's Quality Management (QM) plan. The modification in the QM plan shall not affect the form, fit, or function as described herein. For device class M, sampling and inspection procedures shall be in accordance with MIL-PRF-38535, appendix A.

4.2 Screening. For device classes Q and V, screening shall be in accordance with MIL-PRF-38535, and shall be conducted on all devices prior to qualification and technology conformance inspection. For device class M, screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection.

4.2.1 Additional criteria for device class M.

a. Burn-in test, method 1015 of MIL-STD-883.

(1) Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015.

(2) $T_A = +125^\circ\text{C}$, minimum.

b. Interim and final electrical test parameters shall be as specified in table IIA herein.

4.2.2 Additional criteria for device classes Q and V.

a. The burn-in test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The burn-in test circuit shall be maintained under document revision level control of the device manufacturer's Technology Review Board (TRB) in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1015 of MIL-STD-883.

b. Interim and final electrical test parameters shall be as specified in table IIA herein.

c. Additional screening for device class V beyond the requirements of device class Q shall be as specified in MIL-PRF-38535, appendix B.

4.3 Qualification inspection for device classes Q and V. Qualification inspection for device classes Q and V shall be in accordance with MIL-PRF-38535. Inspections to be performed shall be those specified in MIL-PRF-38535 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).

4.4 Conformance inspection. Technology conformance inspection for classes Q and V shall be in accordance with MIL-PRF-38535 including groups A, B, C, D, and E inspections and as specified herein except where option 2 of MIL-PRF-38535 permits alternate in-line control testing. Quality conformance inspection for device class M shall be in accordance with MIL-PRF-38535, appendix A and as specified herein. Inspections to be performed for device class M shall be those specified in method 5005 of MIL-STD-883 and herein for groups A, B, C, D, and E inspections (see 4.4.1 through 4.4.4).

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4.4.1 Group A inspection.

- a. Tests shall be as specified in table IIA herein.
- b. Subgroups 8, 9, 10, and 11 in table I, method 5005 of MIL-STD-883 shall be omitted.

TABLE IIA. Electrical test requirements.

Test requirements	Subgroups (in accordance with MIL-STD-883, method 5005, table I)	Subgroups (in accordance with MIL-PRF-38535, table III)	
	Device class M	Device class Q	Device class V
Interim electrical parameters (see 4.2)	1	1	1
Final electrical parameters (see 4.2)	1*, 2, 3, 4 1/ 2/	1*, 2, 3, 4 1/ 2/	1*, 2, 3, 4 1/ 2/
Group A test requirements (see 4.4)	1, 2, 3, 4, 5, 6, 7	1, 2, 3, 4, 5, 6, 7	1, 2, 3, 4, 5, 6, 7
Group C end-point electrical parameters (see 4.4)	1	1	1 2/
Group D end-point electrical parameters (see 4.4)	1	1	1
Group E end-point electrical parameters (see 4.4)	---	---	---

1/ PDA applies to subgroup 1.

2/ Delta limits as specified in table IIB shall be required where specified, and the delta limits shall be computed with reference to the previous interim electrical parameters.

Table IIB. 240 hour burn-in and group C end-point electrical parameters.

Parameter	Limits		Delta limits	Units
	Min	Max		
V _{os}	-100	100	±75	μV
I _{os}	-2.8	2.8	±1	nA
I _g	-3	3	±1	nA

4.4.2 Group C inspection. The group C inspection end-point electrical parameters shall be as specified in table IIA herein.

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4.4.2.1 Additional criteria for device class M. Steady-state life test conditions, method 1005 of MIL-STD-883:

- a. Test condition A, B, C, or D. The test circuit shall be maintained by the manufacturer under document revision level control and shall be made available to the preparing or acquiring activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.
- b. $T_A = +125^\circ\text{C}$, minimum.
- c. Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

4.4.2.2 Additional criteria for device classes Q and V. The steady-state life test duration, test condition and test temperature, or approved alternatives shall be as specified in the device manufacturer's QM plan in accordance with MIL-PRF-38535. The test circuit shall be maintained under document revision level control by the device manufacturer's TRB in accordance with MIL-PRF-38535 and shall be made available to the acquiring or preparing activity upon request. The test circuit shall specify the inputs, outputs, biases, and power dissipation, as applicable, in accordance with the intent specified in test method 1005 of MIL-STD-883.

4.4.3 Group D inspection. The group D inspection end-point electrical parameters shall be as specified in table IIA herein.

4.4.4 Group E inspection. Group E inspection is required only for parts intended to be marked as radiation hardness assured (see 3.5 herein).

- a. End-point electrical parameters shall be as specified in table IIA herein.
- b. For device classes Q and V, the devices or test vehicle shall be subjected to radiation hardness assured tests a radiation must meet the postirradiation end-point electrical parameter limits as defined in table I at $T_A = +25^\circ\text{C} \pm 5^\circ\text{C}$, after exposure, to the subgroups specified in table IIA herein.
- c. When specified in the purchase order or contract, a copy of the RHA delta limits shall be supplied.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-PRF-38535 for device classes Q and V or MIL-PRF-38535, appendix A for device class M.

6. NOTES

6.1 Intended use. Microcircuits conforming to this drawing are intended for use for Government microcircuit applications (original equipment), design applications, and logistics purposes.

6.1.1 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.2 Configuration control of SMD's. All proposed changes to existing SMD's will be coordinated with the users of record for the individual documents. This coordination will be accomplished in accordance with MIL-STD-973 using DD Form 1692, Engineering Change Proposal.

6.3 Record of users. Military and industrial users should inform Defense Supply Center Columbus when a system application requires configuration control and which SMD's are applicable to that system. DSCC will maintain a record of users and this list will be used for coordination and distribution of changes to the drawings. Users of drawings covering microelectronic devices (FSC 5962) should contact DSCC-VA, telephone (614) 692-0525.

6.4 Comments. Comments on this drawing should be directed to DSCC-VA, Columbus, Ohio 43216-5000, or telephone (614) 692-0674.

6.5 Abbreviations, symbols, and definitions. The abbreviations, symbols, and definitions used herein are defined in MIL-PRF-38535 and MIL-HDBK-1331.

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6.6.1 Sources of supply for device classes Q and V. Sources of supply for device classes Q and V are listed in QML-38535. The vendors listed in QML-38535 have submitted a certificate of compliance (see 3.6 herein) to DSCC-VA and have agreed to this drawing.

6.6.2 Approved sources of supply for device class M. Approved sources of supply for class M are listed in MIL-HDBK-103. The vendors listed in MIL-HDBK-103 have agreed to this drawing and a certificate of compliance (see 3.6 herein) has been submitted to and accepted by DSCC-VA.

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STANDARD MICROCIRCUIT DRAWING BULLETIN

DATE: 97-05-30

Approved sources of supply for SMD 5962-87738 are listed below for immediate acquisition information only and shall be added to MIL-HDBK-103 and QML38535 during the next revision. MIL-HDBK-103 and QML38535 will be revised to include the addition or deletion of sources. The vendors listed below have agreed to this drawing and a certificate of compliance has been submitted to and accepted by DSCC-VA. This bulletin is superseded by the next dated revision of MIL-HDBK-103 and QML38535.

Standard microcircuit drawing PIN 1/	Vendor CAGE number	Vendor similar PIN 2/
5962-8773801GA	07933 24355 64155	OP-77BT/883B OP77BJ/883 LT1001MH/883B
5962-8773801GC	07933	OP-77BT/883B
5962-8773801PA	07933 24355 64155	OP-77BD/883B OP77BZ/883 LT1001MJ8/883B
5962-87738012A	24355	OP-77BRC/883
5962-8773802VGA	24355	OP77AJ/QMLV
5962-8773802GA	07933 24355	OP-77AT/883B OP77AJ/883
5962-8773802GC	07933	OP-77AT/883B
5962-8773802PA	07933 24355	OP-77AD/883B OP77AZ/883
5962-8773802VPA	24355	OP77AZ/QMLV
5962-8773802V2A	24355	OP77ARC/QMLV
5962-8773802VHA	24355	OP77AL/QMLV
5962-8773003GA	64155	LT1001AMH/883
5962-8773803PA	64155	LT1001AMJ8/883

- 1/ The lead finish shown for each PIN representing a hermetic package is the most readily available from the manufacturer listed for that part. The device manufacturers listed herein are authorized to supply alternate lead finishes "A", "B", or "C" at their discretion. Contact the listed approved source of supply for further information.
- 2/ **Caution.** Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.

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STANDARD MICROCIRCUIT DRAWING BULLETIN - continued

<u>Vendor CAGE number</u>	<u>Vendor name and address</u>
07933	Raytheon Company Semiconductor Division 350 Ellis Street Mountain View, CA 94042
24355	Analog Devices Santa Clara Site RT 1 Industrial Park PO Box 9106 Norwood, MA 02062 Point of contact: 1500 Space Park Drive PO Box 58020 Santa Clara, CA 95052-8020
64155	Linear Technology Corporation 1630 McCarthy Boulevard Milpitas, Ca 95035-7487

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